EZ-USB™ FX2G3



USB 2.0 high-speed peripheral controller

EZ-USB™ FX2G3 is a family of USB 2.0 device controllers targeting the established USB 2.0 applications in biometrics, scanner, camera, video and imaging markets. It is based on the MXS40-LP platform with Cortex®-M4 and M0+ MCUs, 512 KB Flash, 128 KB SRAM, 128 KB ROM, serial communication blocks (SCB) and a crypto engine to support various security features. A high bandwidth data subsystem provides DMA data transfers from LVCMOS input to USB output at speeds up to 480 Mbps, USB high-speed based host systems. A 1024 KB SRAM is included in the high bandwidth data subsystem to provide buffering for data.

Key features

- USB interface
 - USB 2.0 HS at 480 Mbps
 - Up to 32 endpoints, 16 IN and 16 OUT; each end point configured as Bulk, Isochronous or Interrupt type

Dual-core CPU subsystem

- 150 MHz Arm® Cortex®-M4F (CM4) CPU with single-cycle multiply, floating point (FP), and memory protection unit (MPU)
- 100 MHz Arm® Cortex®-M0+ (CM0+) CPU with single-cycle multiply and memory protection unit (MPU)

Memory subsystem

- 512 KB built-in application flash, read-while-write (RWW) support
- 128 KB SRAM with power and data retention control
- 128 KB ROM for device initialization, flash write, security, eFuse programming
- 1 MB SRAM for LVCMOS to USB data buffer
- 1024 bits one-time programmable (OTP) eFuse array

General Programmable Interface (GPIF III)

- LVCMOS parallel-data bus transceiver mode
 - Consists of 16 data, one clock, and 10 control signals
- 100 MHz SDR in TX and RX mode

Peripheral IO subsystem – total of 48 shared IOs

- Quad SPI (QSPI) configurable as single, dual, quad, dual-quad, and octal interfaces
- Six Serial Communication Blocks (SCBs) configurable as I2C, UART, or SPI
- Pulse-density modulation (PDM) to pulse-code modulation (PCM) converter for microphone
- One USB Full-Speed (FS) device for virtual communication (COM) function
- GPIOs: Each peripheral IO can be configured as GPIO

· Ultra-low-power (ULP) with fine-grained power management

- 1.7 V to 3.6 V operation
- Deep Sleep mode with SRAM retention

Flexible clocking options

Security

- ROM-based root of trust via uninterrupted "Secure Boot"
- Stepwise authentication of execution images
- Secured execution of code in the execute-only mode for protected routines
- All debug and test ingress paths can be disabled
- Eight protection contexts
- Cryptography accelerator
- Hardware acceleration for symmetric and asymmetric cryptographic methods and hash functions
- True random number generation (TRNG) function

Package information

- 8 mm × 8 mm 104-pin LGA



Applications

- Biometric devices
- Scanners
- Medical devices
- Video streaming cameras
- Audio devices
- Industrial automation
- Gaming controllers & AR/VR
- Data acquisition systems
- USB logic & protocol analysers,
 JTAG debuggers
- USB smartphone add-on accessories

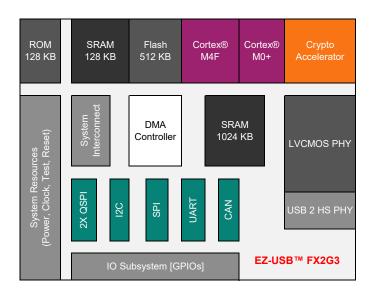
Development tools

- Modus Toolbox[™] software enables cross-platform code development platform
- EZ-USB™ Code Builder along with firmware code examples (including UVC, UAC, HID, CDC, and vendor-specific classes)
- EZ-USB™ GPIF III designer and
 EZ-USB™ FX Control center
- Infineon Developer Community connects you with fellow USB developers worldwide, 24/7.

Key benefits

- Faster, Scalable Data Transfers with 480Mbps speed
- Handles complex designs with enhanced power & memory
- Enables Future-ready connectivity with crypto security
- Optimized for consumer, industrial, automotive applications
- Accelerates development with Infineon's Software Development Platform

Block diagram



Ordering information

Part number	Package	Temp (DegC)	мси	SRAM (KB)	FLASH (KB)	GPIF/ FIFO	No. of SCBs	I2C UART	SPI	CAN	QSPI	Crypto
CYUSB2315-BF104AXI(T)	104 LGA	-45 to 85	M0+	512	256	16-bit	1	Yes				
CYUSB2316-BF104AXI(T)	104 LGA	-45 to 85	M0+	512	256	16-bit	3	Yes	Yes	Yes		
CYUSB2317-BF104AXI(T)	104 LGA	-45 to 85	M0+	512	512	16-bit	6	Yes	Yes	Yes	Yes	
CYUSB2318-BF104AXI(T)	104 LGA	-45 to 85	M4/M0+	1024	512	16-bit	6	Yes	Yes	Yes	Yes	Yes



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